

# SN54HCT245, SN74HCT245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCLS020D – MARCH 1984 – REVISED DECEMBER 2002

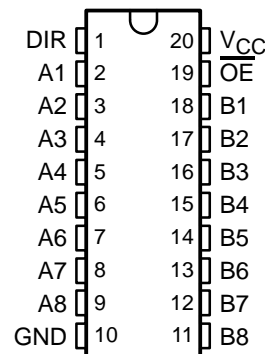
- Operating Voltage Range of 4.5 V to 5.5 V
- High-Current 3-State Outputs Drive Bus Lines Directly or Up To 15 LSTTL Loads
- Low Power Consumption, 80- $\mu$ A Max  $I_{CC}$
- Typical  $t_{pd} = 14$  ns
- $\pm 6$ -mA Output Drive at 5 V
- Low Input Current of 1  $\mu$ A Max
- Inputs Are TTL-Voltage Compatible

## description/ordering information

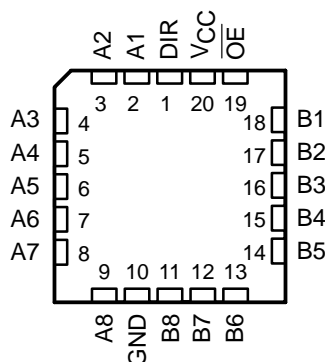
These octal bus transceivers are designed for asynchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

The 'HCT245 devices allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending upon the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the device so that the buses are effectively isolated.

## SN54HCT245 . . . J OR W PACKAGE SN74HCT245 . . . DB, DW, N, NS, OR PW PACKAGE (TOP VIEW)



## SN54HCT245 . . . FK PACKAGE (TOP VIEW)



## ORDERING INFORMATION

$T_A$	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	PDIP – N	Tube	SN74HCT245N	SN74HCT245N
	SOIC – DW	Tube	SN74HCT245DW	HCT245
		Tape and reel	SN74HCT245DWR	
	SOP – NS	Tape and reel	SN74HCT245NSR	HCT245
	SSOP – DB	Tape and reel	SN74HCT245DBR	HT245
-55°C to 125°C	TSSOP – PW	Tube	SN74HCT245PW	HT245
		Tape and reel	SN74HCT245PWR	
	CDIP – J	Tube	SNJ54HCT245J	SNJ54HCT245J
	CFP – W	Tube	SNJ54HCT245W	SNJ54HCT245W
	LCCC – FK	Tube	SNJ54HCT245FK	SNJ54HCT245FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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**TEXAS  
INSTRUMENTS**

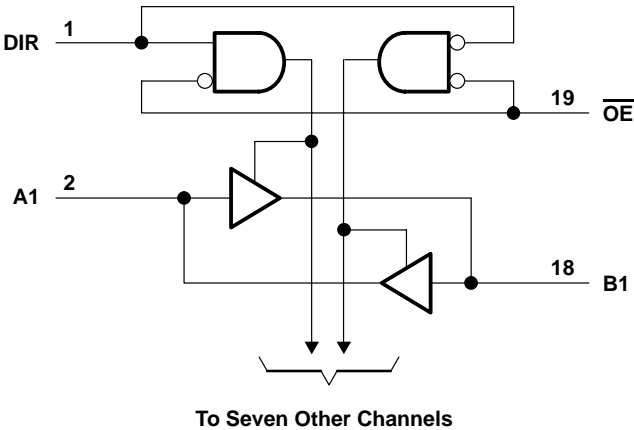
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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

FUNCTION TABLE

INPUTS		OPERATION
$\overline{OE}$	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$	−0.5 V to 7 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see Note 1)	±20 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) (see Note 1)	±20 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	±35 mA
Continuous current through $V_{CC}$ or GND	±70 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2):	
DB package	70°C/W
DW package	58°C/W
N package	69°C/W
NS package	60°C/W
PW package	83°C/W
Storage temperature range, $T_{stg}$	−65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51-7.

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SCLS020D – MARCH 1984 – REVISED DECEMBER 2002

## recommended operating conditions (see Note 3)

			SN54HCT245			SN74HCT245			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V <sub>CC</sub>	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
V <sub>IH</sub>	High-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2			2			V
V <sub>IL</sub>	Low-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V			0.8			0.8	V
V <sub>I</sub>	Input voltage		0	V <sub>CC</sub>		0	V <sub>CC</sub>		V
V <sub>O</sub>	Output voltage		0	V <sub>CC</sub>		0	V <sub>CC</sub>		V
Δt/Δv	Input transition rise/fall time				500			500	ns
T <sub>A</sub>	Operating free-air temperature		–55		125	–40		85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V <sub>CC</sub>	T <sub>A</sub> = 25°C			SN54HCT245		SN74HCT245		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V <sub>OH</sub>		V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OH</sub> = –20 μA	4.5 V	4.4	4.499		4.4		4.4		V
				3.98	4.3		3.7		3.84		
V <sub>OL</sub>		V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OL</sub> = 20 μA	4.5 V		0.001	0.1		0.1		0.1	V
					0.17	0.26		0.4		0.33	
I <sub>I</sub>	DIR or $\overline{\text{OE}}$	V <sub>I</sub> = V <sub>CC</sub> or 0	5.5 V	±0.1	±100		±1000		±1000		nA
I <sub>OZ</sub>	A or B	V <sub>O</sub> = V <sub>CC</sub> or 0	5.5 V	±0.01	±0.5		±10		±5		μA
I <sub>CC</sub>		V <sub>I</sub> = V <sub>CC</sub> or 0, I <sub>O</sub> = 0	5.5 V			8	160		80		μA
ΔI <sub>CC</sub> †		One input at 0.5 V or 2.4 V, Other inputs at 0 or V <sub>CC</sub>	5.5 V		1.4	2.4	3		2.9		mA
C <sub>i</sub> ‡	DIR or $\overline{\text{OE}}$		4.5 V to 5.5 V		3	10	10		10		pF

† This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V<sub>CC</sub>.

‡ Parameter C<sub>i</sub> does not apply to transceiver I/O ports.

## switching characteristics over recommended operating free-air temperature range, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub>	T <sub>A</sub> = 25°C			SN54HCT245		SN74HCT245		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A or B	B or A	4.5 V		16	22		33		28	ns
			5.5 V		14	20		30		25	
t <sub>en</sub>	$\overline{\text{OE}}$	A or B	4.5 V		25	46		69		58	ns
			5.5 V		22	41		62		52	
t <sub>dis</sub>	$\overline{\text{OE}}$	A or B	4.5 V		26	40		60		50	ns
			5.5 V		23	36		54		45	
t <sub>t</sub>		A or B	4.5 V		9	12		18		15	ns
			5.5 V		8	11		16		14	



# SN54HCT245, SN74HCT245

## OCTAL BUS TRANSCEIVERS

### WITH 3-STATE OUTPUTS

SCLS020D – MARCH 1984 – REVISED DECEMBER 2002

switching characteristics over recommended operating free-air temperature range,  $C_L = 150 \text{ pF}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC}$	$T_A = 25^\circ\text{C}$			SN54HCT245		SN74HCT245		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$t_{pd}$	A or B	B or A	4.5 V		20	30		45		38	ns
			5.5 V		18	27		41		34	
$t_{en}$	$\overline{OE}$	A or B	4.5 V		36	59		89		74	ns
			5.5 V		30	53		80		67	
$t_t$		A or B	4.5 V		17	42		63		53	ns
			5.5 V		14	38		57		48	

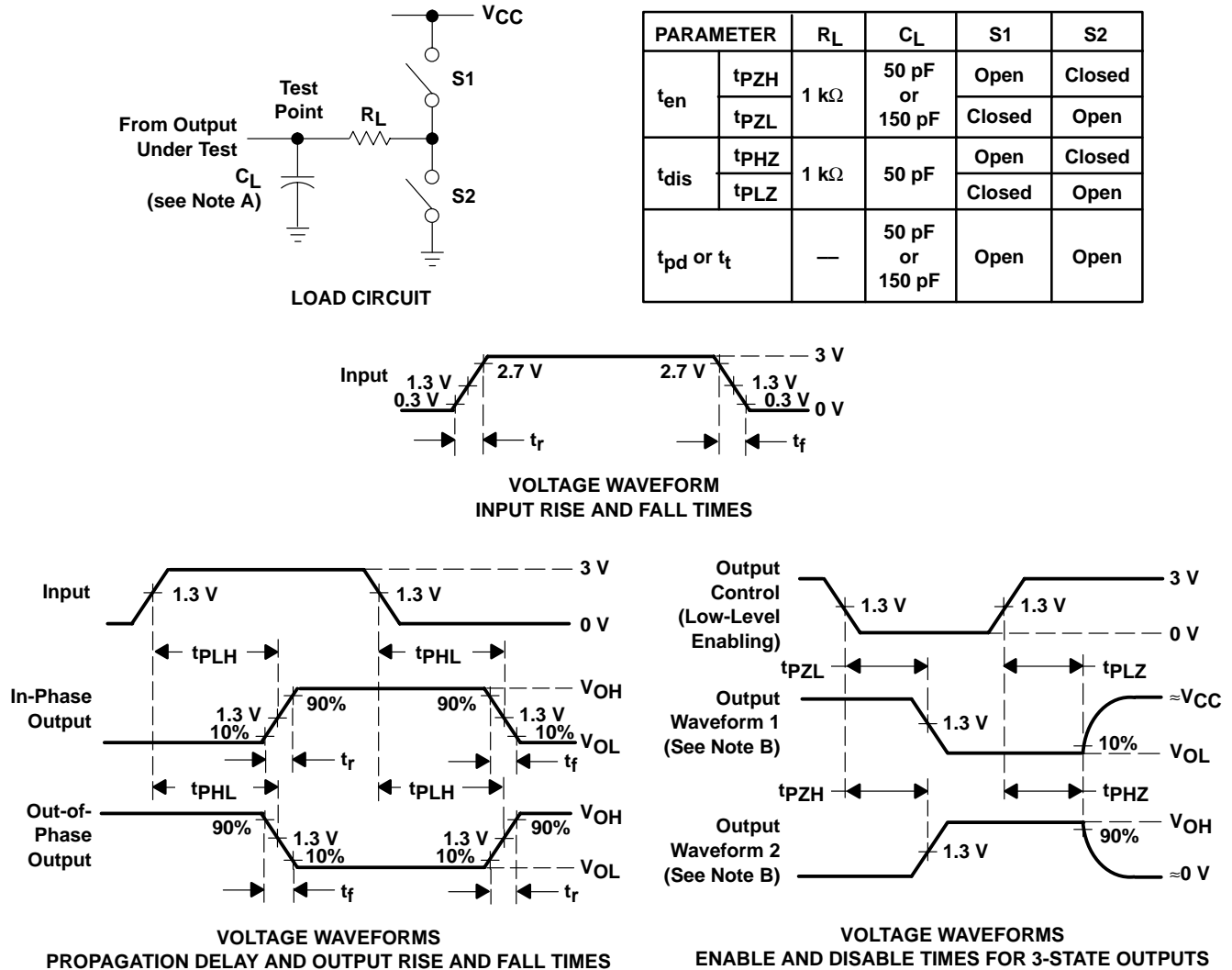
operating characteristics,  $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
$C_{pd}$	Power dissipation capacitance per transceiver	No load	40	pF



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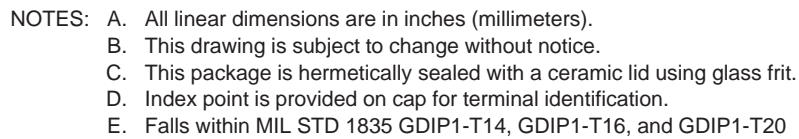
## PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A.  $C_L$  includes probe and test-fixture capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1$  MHz,  $Z_O = 50 \Omega$ ,  $t_r = 6$  ns,  $t_f = 6$  ns.
  - D. The outputs are measured one at a time with one input transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

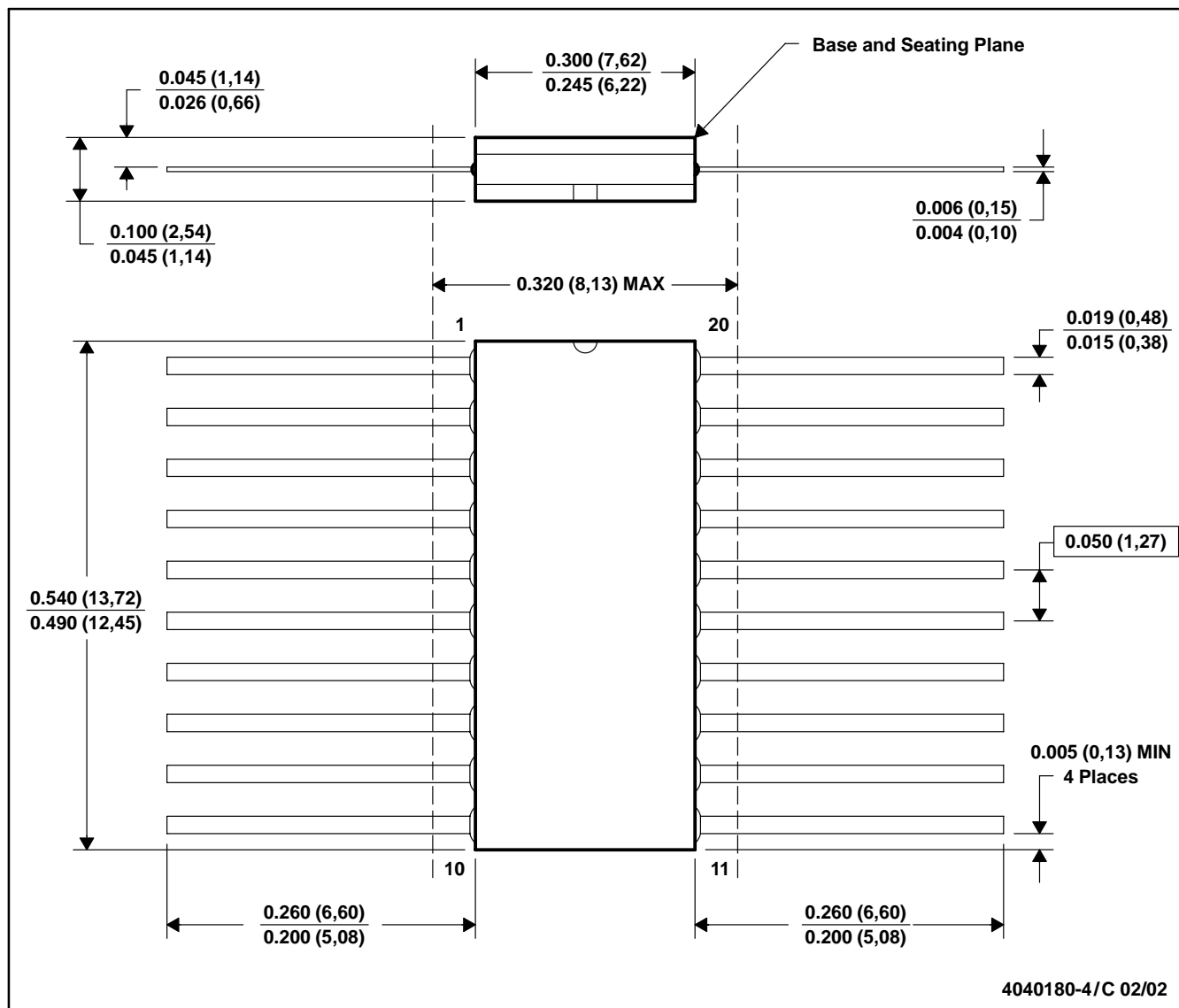
Figure 1. Load Circuit and Voltage Waveforms

## 14 LEADS SHOWN



W (R-GDFP-F20)

CERAMIC DUAL FLATPACK

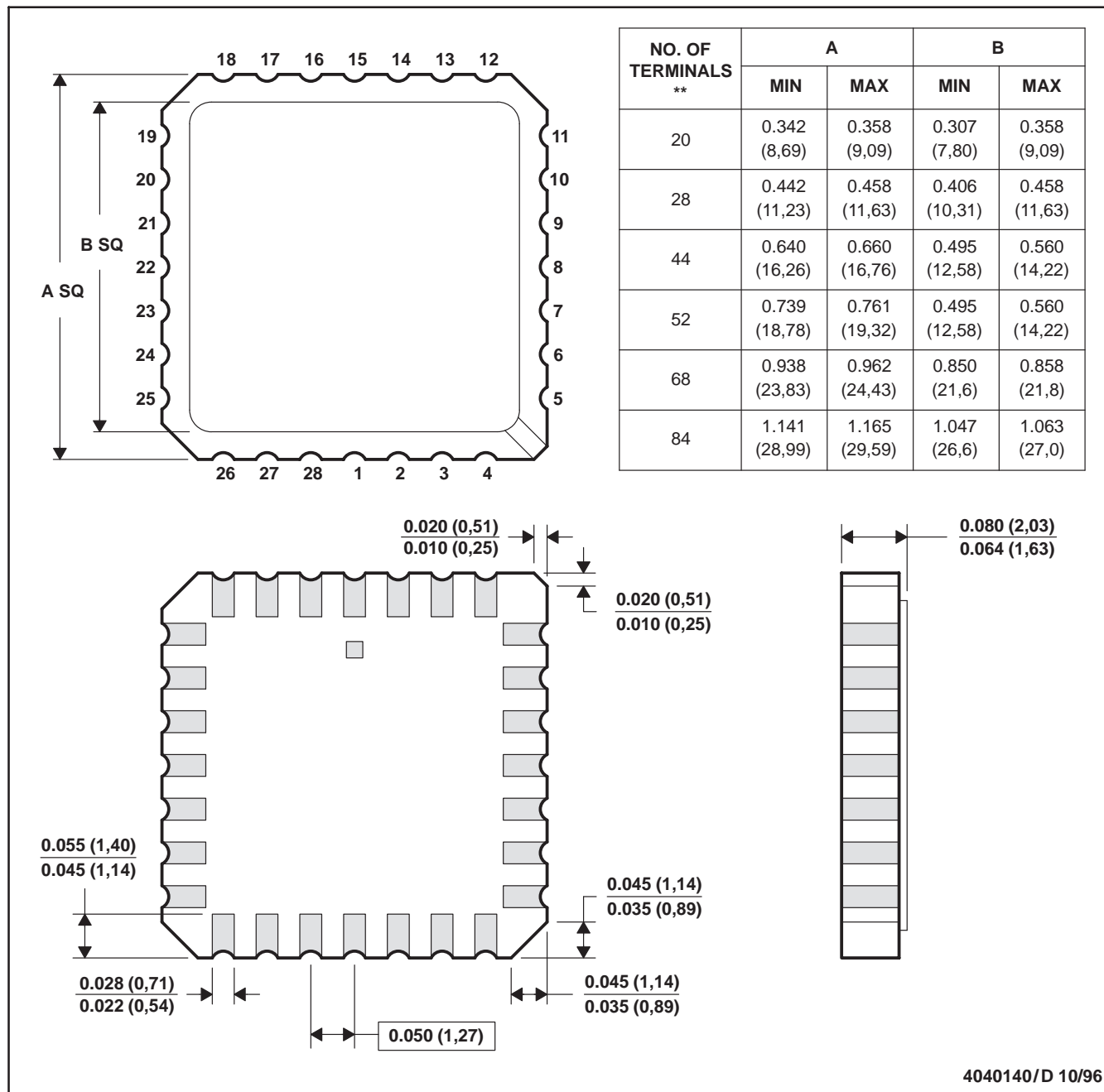


- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only.

## FK (S-CQCC-N\*\*)

## LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN

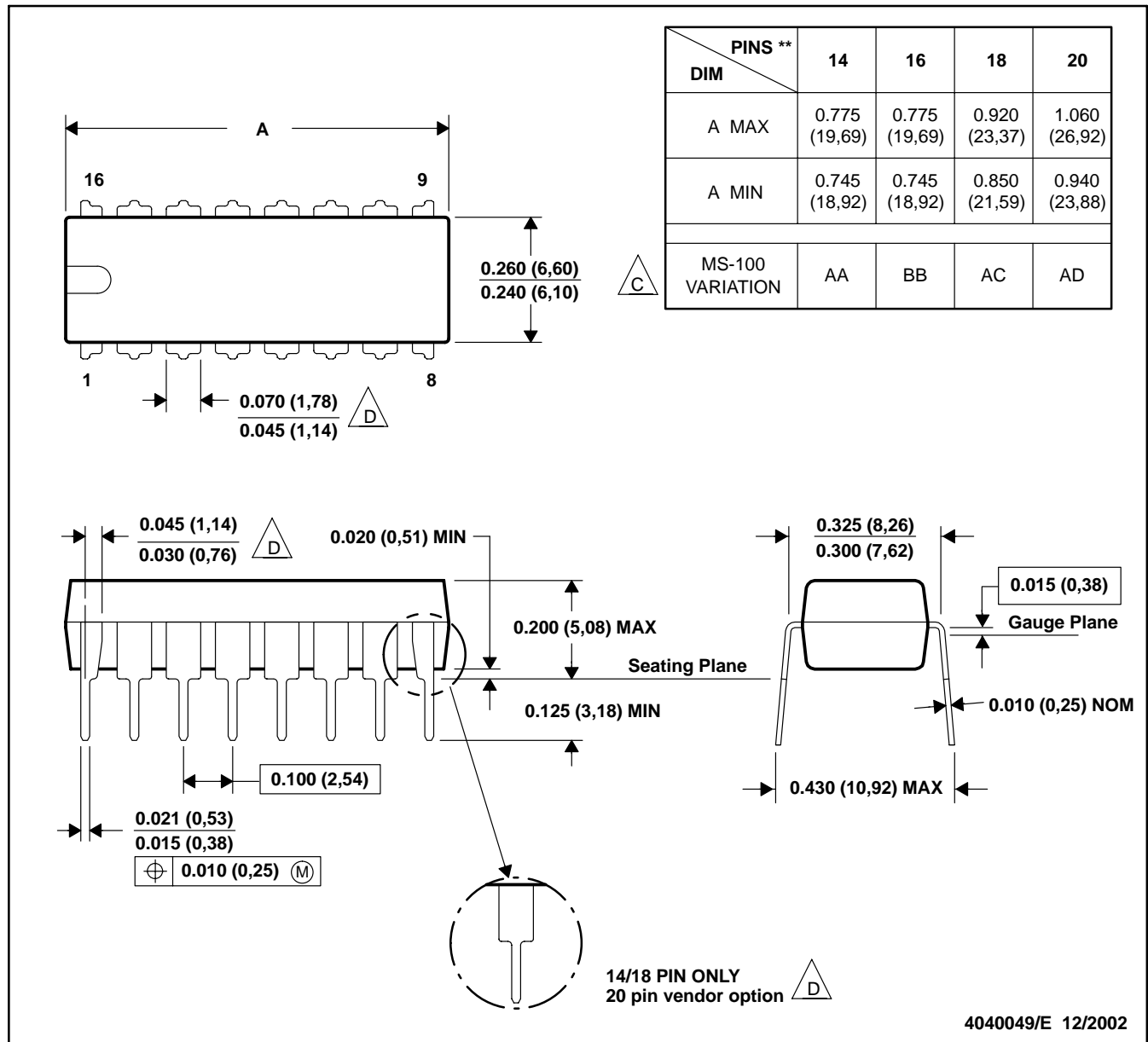


- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - The terminals are gold plated.
  - Falls within JEDEC MS-004



**N (R-PDIP-T\*\*)**

16 PINS SHOWN

**PLASTIC DUAL-IN-LINE PACKAGE**

NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

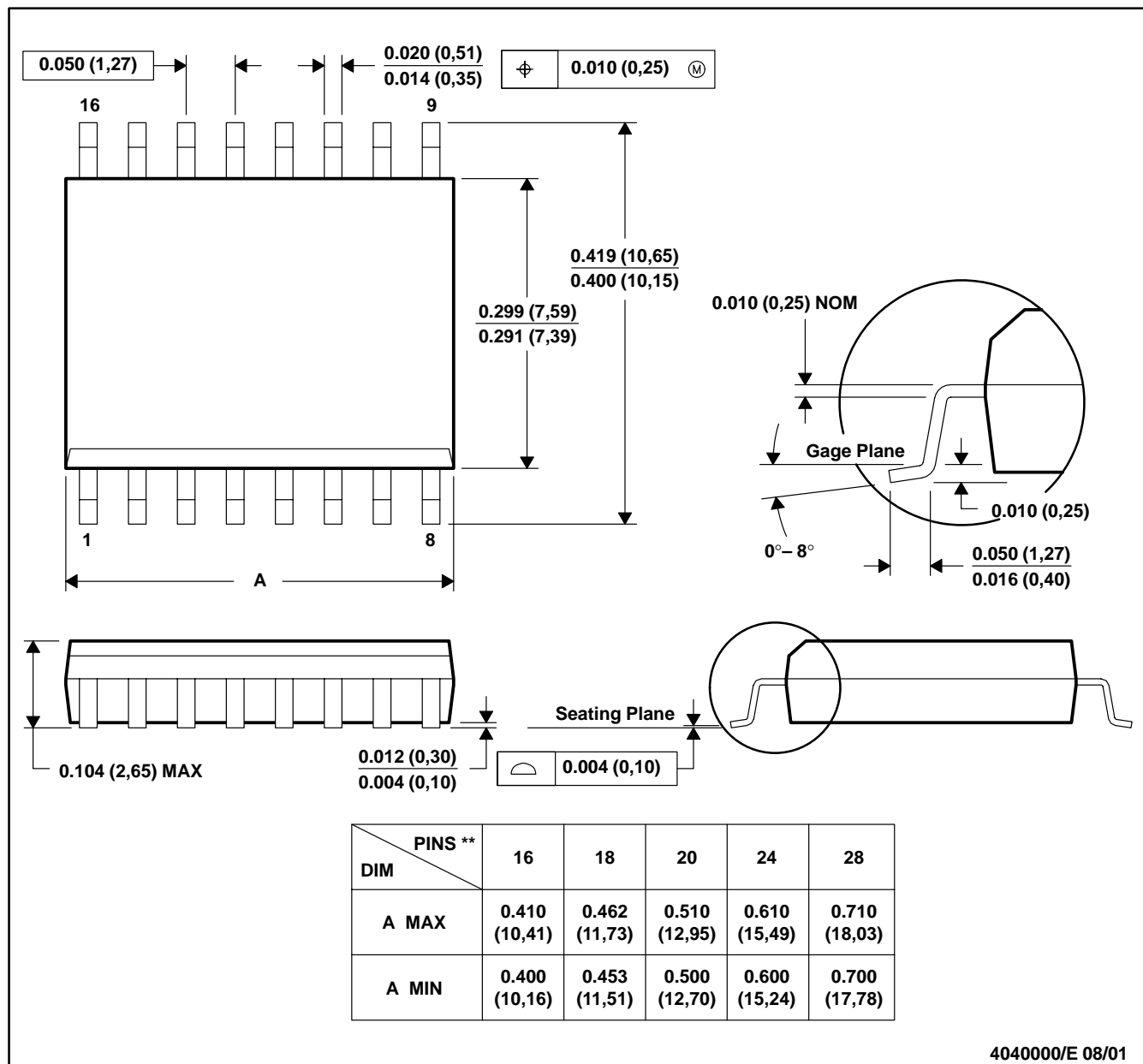
C Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

D The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

16 PINS SHOWN

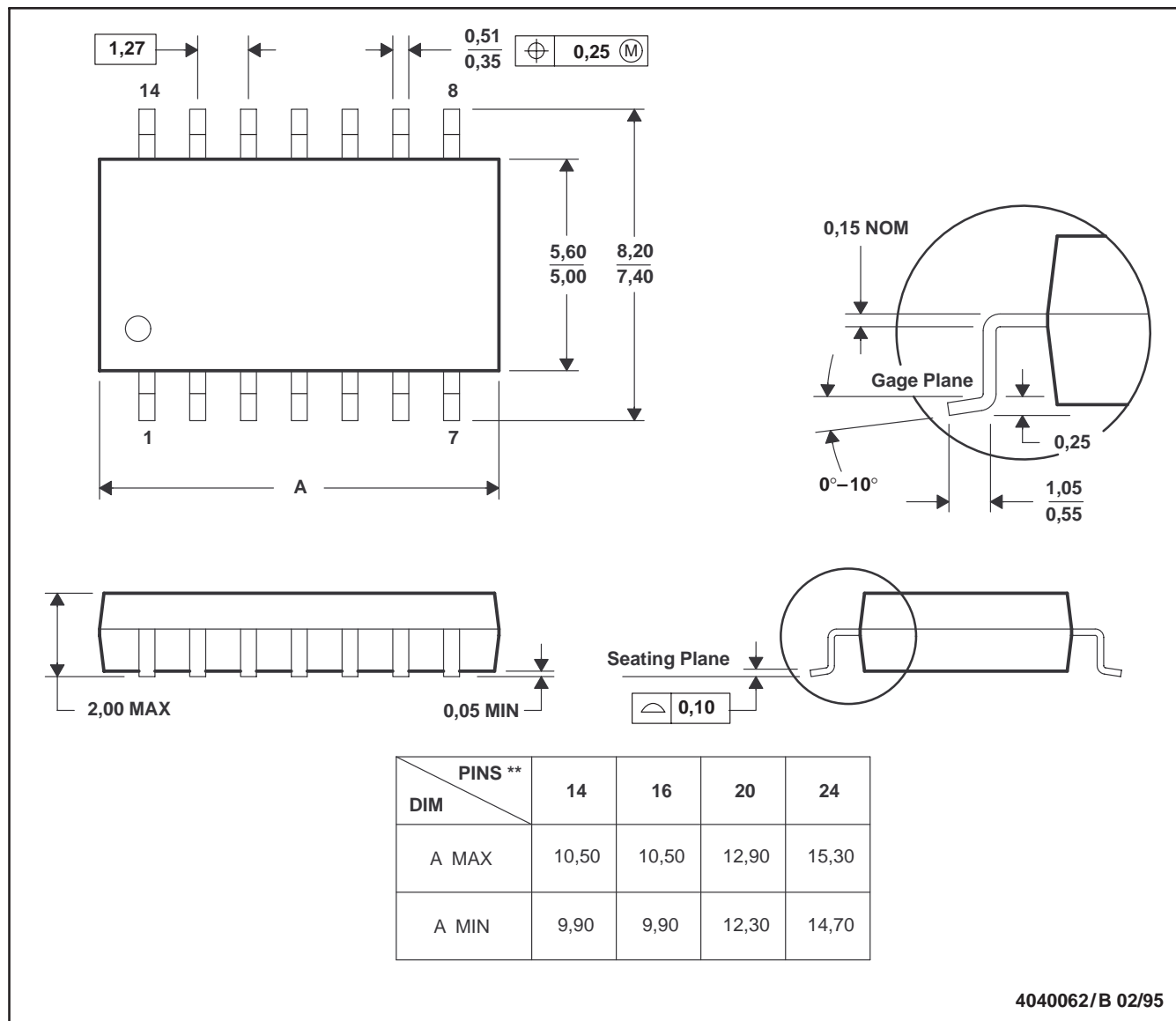


- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MS-013

## NS (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

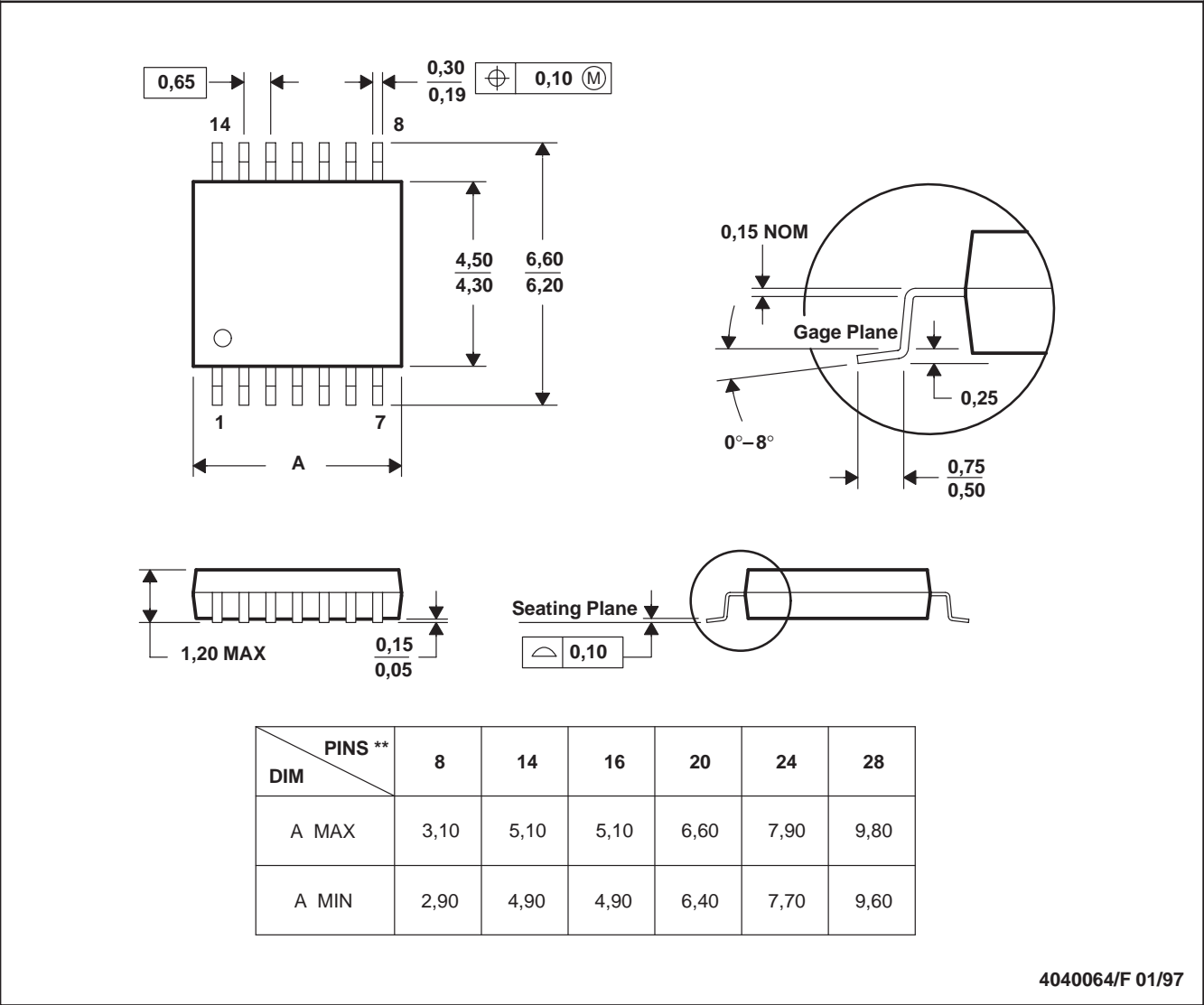
28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

PW (R-PDSO-G\*\*)  
14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES: A. All linear dimensions are in millimeters.  
B. This drawing is subject to change without notice.  
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
D. Falls within JEDEC MO-153

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